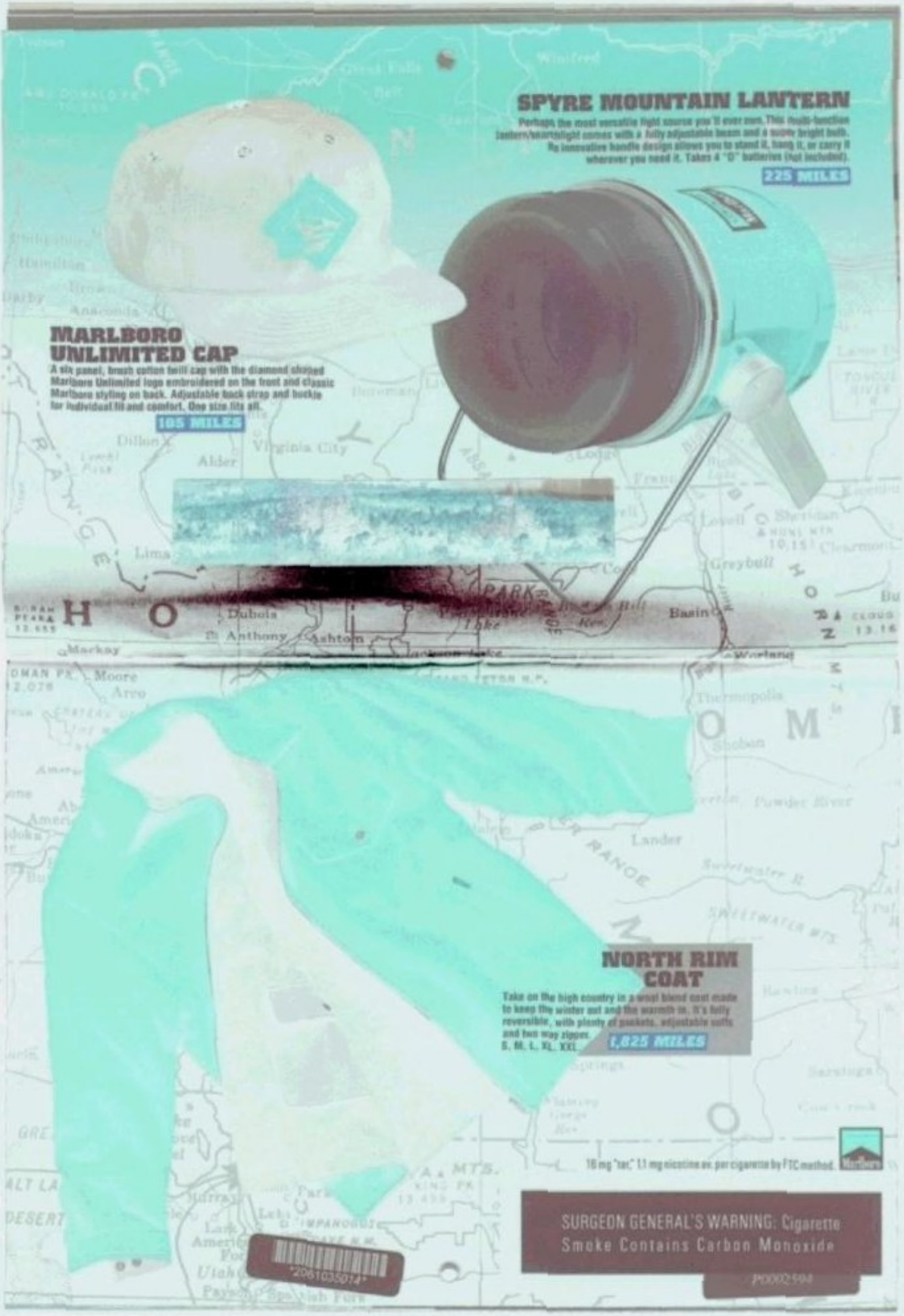

Source: https://www.industrydocuments.ucsf.edu/docs/qlnp0003
2061035014